

Femtosecond X-ray Source Instrumentation

Initial Concepts

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- **BPM's**

1) Single shot turn-by-turn capability, basic requirements:

Dynamic Range = 0.01 nC – 5 nC

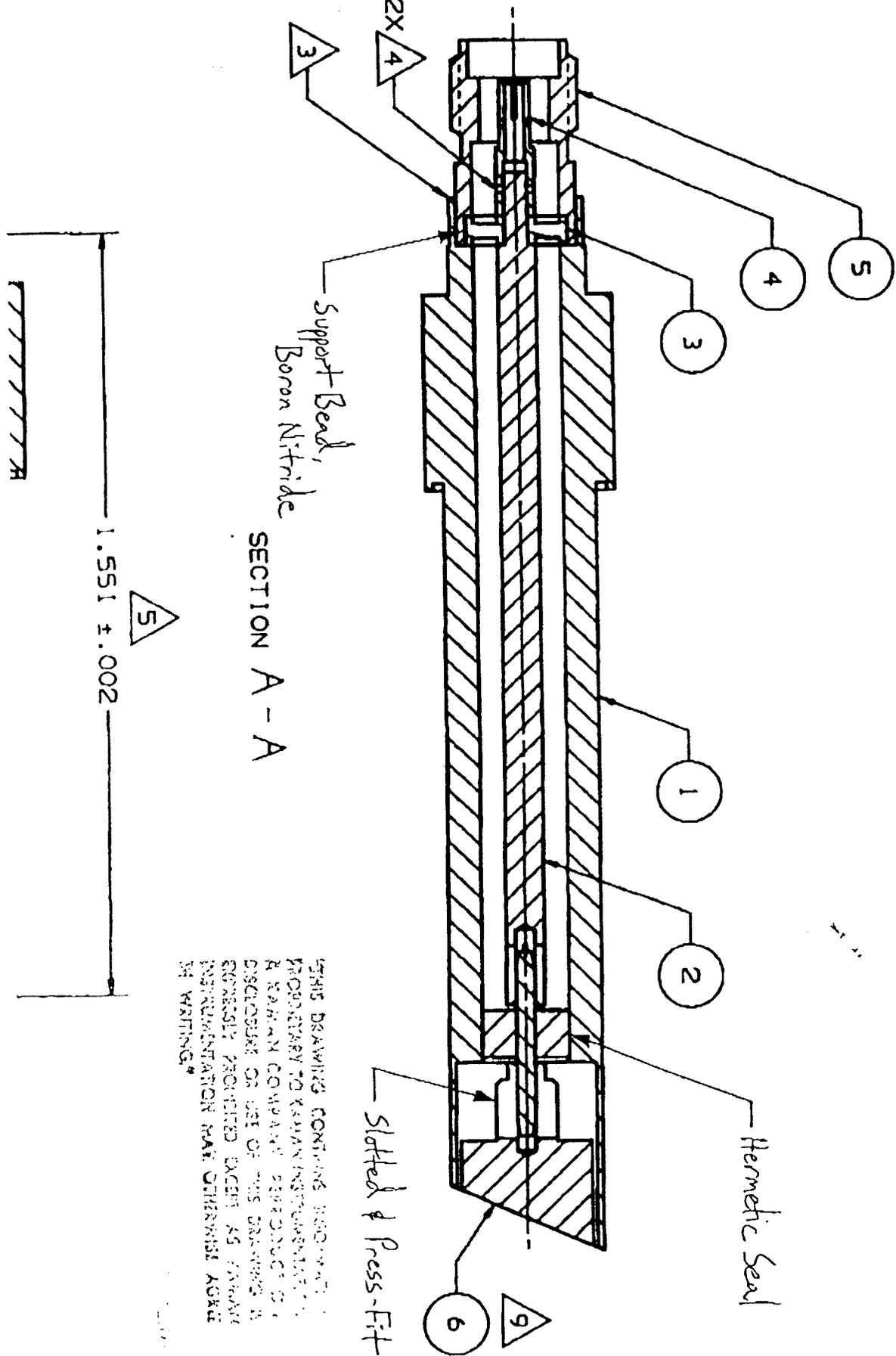
Resolution:

20 um @ 1 nC

100 um @ 0.1 nC

1000 um @ 0.01 nC

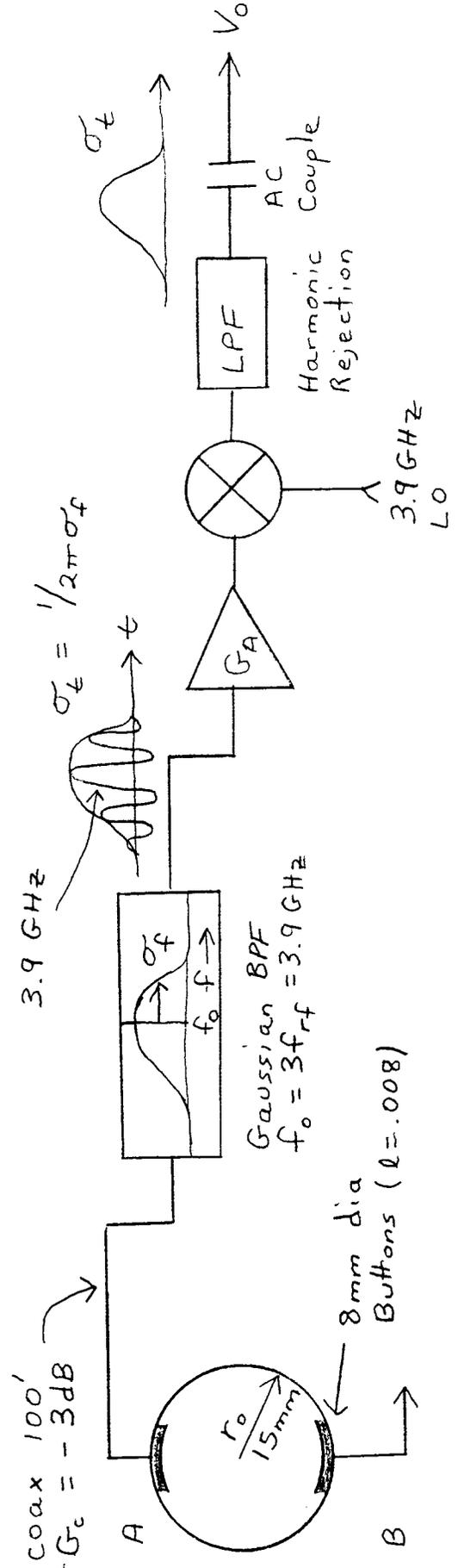
- 2) Electrostatic button pickups, 50 ohm, welded-in vacuum chamber for compactness.
- 3) Detection at $3x f_{rf} = 3.9$ GHz for maximum sensitivity, heterodyne down conversion of pulse to baseband.
- 4) Direct digitization of individual pickups with on a turn-by-turn basis (approximately 1MHz in linac) with a bunch rate of 10 kHz using multichannel A/D's. Allows bunch-by-bunch position determination.
- 5) Broad array of processing and calibration algorithms are possible at 10 kHz rate. Prototyping at ALS Linac possible.
- 6) Issue – ring turn time not equal (increasing pass lengths), special attention needs to be paid to clocking system.
- 7) Cost \$4k per location?



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BPM Front-End Detection Model



For short bunches BPF dominates

$$V_0(t) = \frac{-t^2 / 2\sigma_t^2}{V_b C_b \sqrt{2\pi} \sigma_t}$$

$g = l / 8r_0 = .067$ $V_b = 3 \times 10^8 \text{ m/sec}$

$q = 0.01 - 5 \text{ nC}$ $C_b = 4 \times 10^{-12} \text{ f}$ (measured on similar existing buttons)

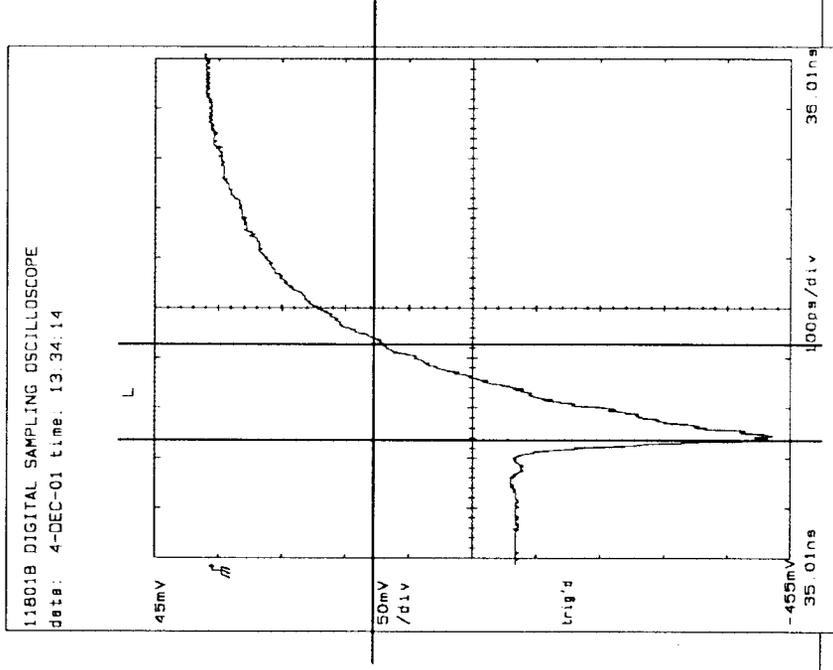
$\sigma_t = 6 \text{ ns}$ for sampling accuracy, $\sigma_f \approx 27 \text{ MHz}$

Example: $q = 1 \text{ nC}$, $G_c = .707$, $G_A = 1$ gives:

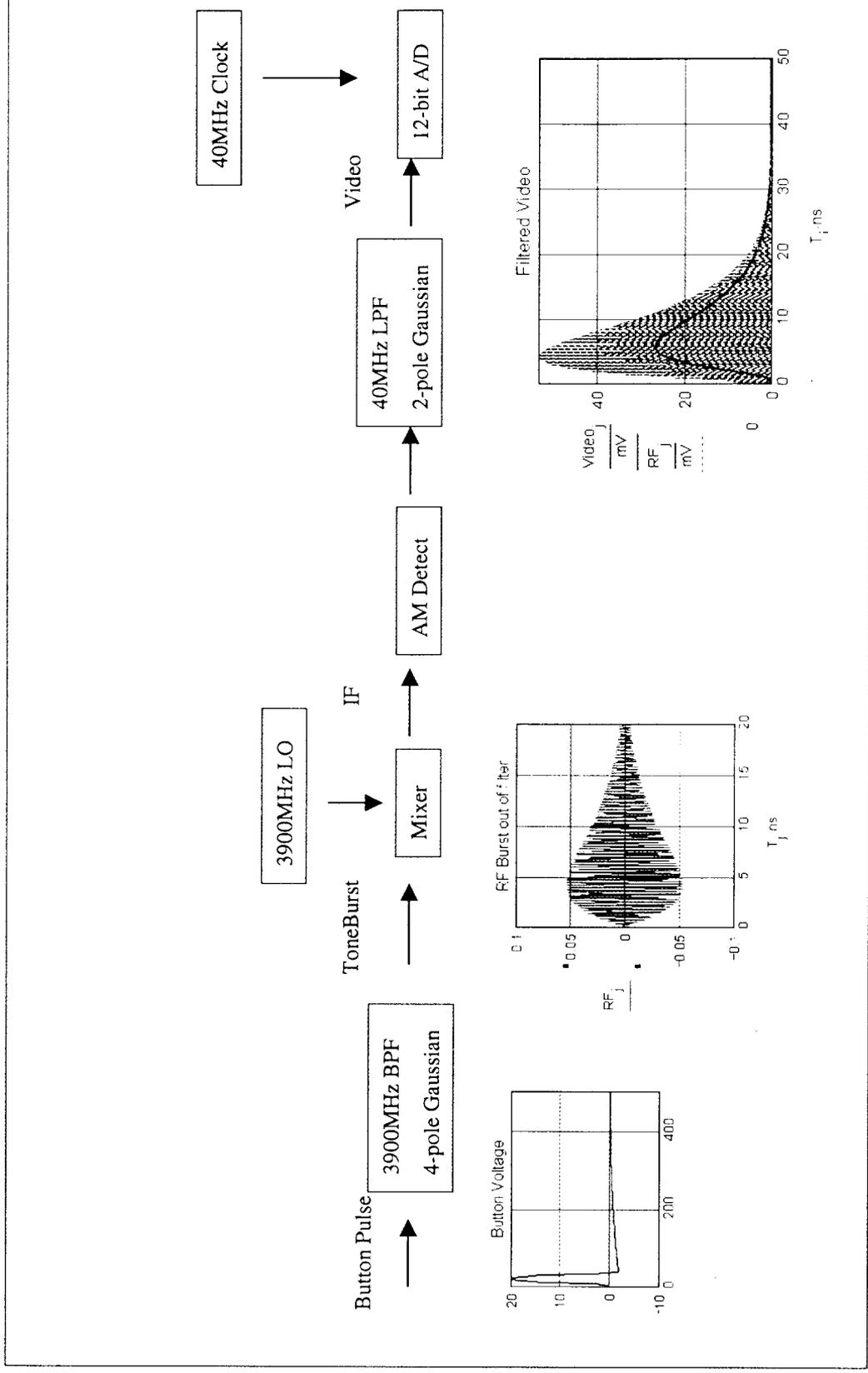
$$V_0(t) = .021 e^{-t^2 / 2\sigma_t^2} \quad (21 \text{ mV peak with no gain})$$

ALS Button TDR Measurement

- $C_b \approx 200\text{ps} / 50\Omega = 4\text{pF}$



Single Channel Block Diagram



BPM Resolution

Specs:

$$\begin{aligned} 20 \mu\text{m} &\rightarrow 1 \text{ nC} \\ 100 \mu\text{m} &\rightarrow 0.1 \text{ nC} \\ 1000 \mu\text{m} &\rightarrow 0.01 \text{ nC} \end{aligned}$$

$$\text{Let: } V_{\Delta} = V_A - V_B$$

$$V_{\Sigma} = V_A + V_B = .042 \quad \text{for } q = 1 \text{ nC}$$

$$\frac{V_{\Delta}}{V_{\Sigma}} = \frac{2\Delta x}{r_0}$$

Assume: kT input noise + kT for amplifier,
($kT = 3 \text{ dB}$ noise figure)

$$BW = 54 \text{ MHz}$$

Equivalent "peak noise" $V_n = \sqrt{4kTRB}$ $R = 50 \Omega$

Also, assume we want $V_{\Delta} \geq 3V_n = 2 \times 10^{-5}$ Volts

By looking at Δx required to achieve this voltage we get:

<u>q</u>	<u>Δx_{min}</u>
1.0 nC	3.6 μm
0.1 nC	36 μm
0.01 nC	360 μm

This is probably optimistic but it seems reasonable that specs can be met.

Also, probably need 6dB matching attenuators at buttons so multiply above by 2.

Electronics – A/Ds

- AD6644 Analog Devices ADC, 65 MHz, 14 bits
- AD9430 Analog Devices ADC, 210 MHz, 12 bits
- ADS852 Burr-Brown ADC, 65 MHz, 14 bits
- ADS808 Burr-Brown ADC, 80 MHz, 12 bits
- Many other options in 12-bit \approx 100MHz
- Clock A/Ds at 40.6MHz (RF/32)

BPM Future Work

- More sophisticated front-end modelling.
- Down conversion techniques - heterodyne, IQ, intermediate (IF) frequency
- Digital electronics design
- Clocking system for increasing turn times.
- Literature search for existing systems
- Experimental work at ALS

- **BCM's (Bunch Charge Monitors)**
 - 1) "Off-the-shelf" from Bergoz, cost TBD.
- **BLM's (Beam Loss Monitors)**
 - 1) Most likely a combination of CLIC (coaxial linear ionization chamber), Cherenkov detectors and diode based detectors.
 - 2) CLIC used at SLAC is cheap and allows continuous pinpoint coverage. Sensitivity is approximately 3 mV/J to over 130mV/J depending on chamber gas mixture etc. May not meet 0.01nC loss spec. More information from SLAC required.
- **Bunch-by-Bunch/Turn-by-Turn Phase Monitor**
 - 1) Simple phase detection against MO at some harmonic of fr. Digitize result. Similar detection and clocking considerations as BPM
- **Photon-Based Diagnostics**
 - 1) Synchrotron light monitors for transverse profile. Frame grabbers. Pepper pot and imaging for emittance. Low- energy first turn needs study.
 - 2) Streak cameras for longitudinal measurements, \$100 k per location.
- **Intercepting Diagnostics**
 - 1) Phosphor screens (Alumina paddles doped with Chromox 6), "harps", etc. for steering, profile and emittance. *Significant Mechanical Engineering component.*
- **Laser-to-bunch timing** – See John Byrd talk
 - 1) Ultra stable RF phase-lock –loop techniques. Femtosecond measurement issues, AM-to-PM noise conversion. Prototype what has already been done in the field and take it from there.

Beam Charge monitors

Off the shelf Beam Integrating Transformer (BIT) from Bergoz.

- i) Very wide band
- ii) Will measure .1 nC to 1 % accuracy
- iii) Noise floor for 1nC ~ 8 pC
- iv) Can operate at 10 KHz
- v) Cost per unit approx: \$20K

